

# DOT MATRIX LIQUID CRYSTAL DISPLAY MODULE

# USER' MANUAL

# **MODEL: HTM12864B**

PROPO	OSED BY	APPROVED
Design	Approved	

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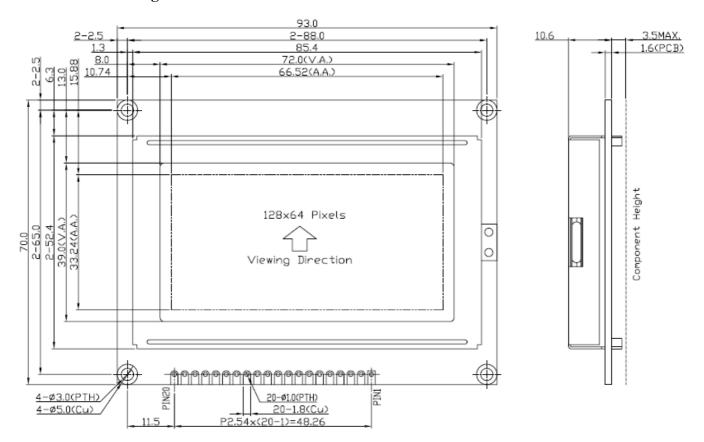
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HOTDISPLAY HTM12864B-25W-N5P

# 1. Mechanical Specification

ITEM	STANDARD	VALUE	UNIT								
DOT MATRIX FORMAT	128 X 64 D	128 X 64 DOTS									
MODULE DIMENSION	93.0 (W) X 70.0 (F	mm									
VIEWING DISPLAY AREA	72.0 (W) X 3	9.0 (H)	mm								
ACTIVE DISPLAY AREA	66.52 (W) X 3	3.24 (H)	mm								
DOT SIZE	0.48 (W) X 0	.48 (H)	mm								
DOT PITCH	0.52 (W) X 0	.52 (H)	mm								
LCD TYPE	STN-YG\Positive\	Transflective									
LED Backlight Color	WHITE										
LED Backlight Input	DC +5.0V V	60	mA								
BACKLIGHT Half-Lift TIME	50,00	00	HR.								

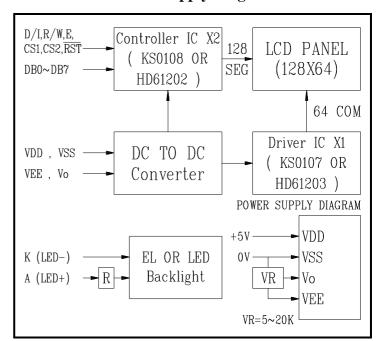
## 2. Mechanical Diagram



#### 3. Interface Pin Connections

NO	SYMBOL	LEVEL	FUNCTION
1	VSS		GND ( 0V)
2	VDD	H/L	DC +5V
3	VO	H/L	Contrast Adjust
4	D/I	H/L	Data / Instruction code
5	R/W	H/L	Read / Write
6	E	Н,Н→L	Enable signal
7	DB0	H/L	Data Bit 0
8	DB1	H/L	Data Bit 1
9	DB2	H/L	Data Bit 2
10	DB3	H/L	Data Bit 3
11	DB4	H/L	Data Bit 4
12	DB5	H/L	Data Bit 5
13	DB6	H/L	Data Bit 6
14	DB7	H/L	Data Bit 7
15	CS1	Н	Chip 1 enable signal
16	CS2	Н	Chip 2 enable signal
17	/RST	L	Reset signal
18	VEE	DC -5V	Negative voltage output
19	A+		LED+( Backlight)
20	K-		LED-( Backlight)

#### 4. Black And Power Supply Diagram



### 5. Electrical Absolute Maximum Ratings

ITEM	SYMBOL	MIN.	TYPE	MAX.	UNIT
SUPPLY VOLTAGE FOR LOGIC	VDD-VSS		5.0	6.5	V
SUPPLY VOLTAGE FOR LCD	VDD-VEE			10.0	V
INPUT VOLAGE	VI	VSS		VDD	V
OPERATING TEMP.	TO	-20		+70	°C
STORAGE TEMP.	TS	-30		+80	°C

#### 6. Environmental absolute maximum ratings

ITEM	OPER	ATING	STOF	RAGE	REMARKS	
	MIN. MAX.		MIN.	MAX.		
Ambient Temperature	0/-20 °C 50/70 °C		-10/-30 °C 60/80 °C		NOTE 1	
Humidity	NO	NOTE 1		ГЕ 2	Without Condensation	
Vibration	4.9m/s <sup>2</sup>		19.6m/s <sup>2</sup>		XYZ Directions	
Shock		$29.4 \text{m/s}^2$		$490.0 \text{m/s}^2$	XYZ Directions	

#### Remarks:

NOTE (1): Ta at 60 °C: 50 HR Max. NOTE (2): Ta < 40 °C: 95% RH Max.

Ta > 40  $^{\circ}$ C: Absolute humidity must be lower than the humidity of 95% at 40  $^{\circ}$ C.

#### 7. Electrical Characteristics

ITEM	SYN	CONDITION	MIN.	TYPE	MAX.	UNIT
SUPPLY VOLTAGE FOR LOGIC	VDD-VSS		4.5	5.0	5.5	V
SUPPLY VOLTAGE FOR LCD	VDD-VEE	Ta= 25°C	8.0		17.0	V
INPUT HIGH VOLTAGE	VIH	NOTE 1	0.7VDD	1	VDD	V
INPUT LOW VOLTAGE	VIL	NOTE 1	0	1	0.3VDD	V
SUPPLY CURRENT (LOGIC)	IDD	VDD=+5V,VEE=-5V		1	4.0	mA
SUPPLY CURRENT (LCD)	ILCD	VDD=+5V,VEE=-5V		-	3.0	mA

NOTE (1): CS1,CS2,R/W,D/I,DB0~7,E, and RST.

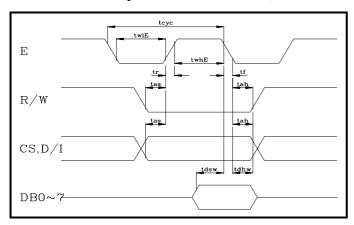
#### 8. Electro-Optical Characteristics

ITEM	SYM	TEMP (°C)	MIN.	TYPE	MAX.	UNIT
	tr	0/-20		2450/3264		ms

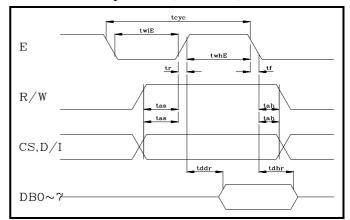
		tr	25		204		ms
RESPONSE TIM	tf	0/-20		600/800		ms	
	tf	25		50		ms	
FRAME FREQUEN	fF			-		Hz	
		0	12.3	13.0	13.7	V	
OPERATING VOLT	AGE	Vop	25	11.0	11.7	12.4	V
			50	10.2	10.9	11.6	V
VIEWING ANGLE	VIEWING ANGLE F-B			55		-	deg
TETTING ANGLE	Qi		60			deg	
CONTRAST RAT	K	25		22.8			

# **9. Timing Control**

Write Operation (NOTE 1)



# Read Operation (NOTE 2)



Item	Symbol	Limit (Min.)	Limit (Max.)	Unit
E cycle	tcyc	1000		ns
E high level width	twhE	450		ns
E low level width	twlE	450		ns
E rise time	tr		25	ns
E fall time	tf		25	ns
Address set-up time	tas	140		ns
Address hold time	tah	10		ns
Data set-up time	tdsw	200		ns
Data delay time	tddr		320	ns
Data hold time (write)	tdhw	10		ns
Data hold time (read)	tdhr	20		ns

#### 10. Instruction Set

FUNCTION	R/W	D/I	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	FUNCTION			
1. Display	0	0	0	0	1	1	1	1	1	1/0	Controls the ON/OFF of the display. RAM data			
ON/OFF											internal status are not affected. 1:ON, 0:OFF.			
2. Display	0	0	1	1	(	lisplay	y start	line (	0~63)	)	Indicates the display data RAM displayed at the			
start line											top of the screen.			
3. Set page	0	0	1	0	1	1	1	pag	ge ( 0~	·7)	Sets the page (X address) of RAM at the page (X			
( X address)											address) register.			
4. Set address	0	0	0	1		Y a	addres	s ( 0~6	53)		Sets the Y address at the Y address counter.			
5. Status Read	1	0	В	0	ON/	R	0	0	0	0	Reads the status.			
			U		OFF	E					RESET 1:Reset, 0:normal.			
			S			S					ON/OFF 1: Display OFF, 0: Display ON.			
			Y			E					BUSY 1: In operation.			
						T					0: Ready			
6. Write	0	1				Write	Data				Writes data (DB0~7) into display data RAM.			
Display Data											After writing instruction, Y address is increased			
											by 1 automatically.			
7. Read	1	1				Read	Data				Reads data (DB0~7) from display data RAM to			
Display Data											the data bus.			

#### 11. Description Of Instructions

#### (1) Display ON/OFF

	R/W	D/I	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
Code	0	0	0	0	1	1	1	1	1	D

The display data appears when D is 1 and disappers when D is 0. Though the data is not on the screen width D=0, it remains in the display data RAM. Therefore, you can make it appear by changing D=0 or D=1.

#### (2) Display start line

	R/W	D/I	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
Code	0	0	1	1	A	A	A	A	A	A

Z address AAAAA (binary) of the display data RAM is set at the display start line register and displayed at the top of the screen.

#### (3) Set page (X address)

	R/W	D/I	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
Code	0	0	1	0	1	1	1	A	A	A

X address AAA (binary) of the display data RAM is set at the X address register. After that, writing or from MPU is executed in this specified page until the next page is set.

#### (4) Set Y address

	R/W	D/I	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
Code	0	0	0	1	A	A	A	A	A	A

Y address AAAAA (binary) of the display RAM is set at the Y address counter is increase by every time data is written or read to or from MPU.

	V 1 2 0 1 0 1 1 0 1 0 1 0 2 0 0 1 1 1 1 1	
DB0 I DB7	PAGE 0	X=0
DB0 I DB7	PAGE 1	X=1
DD/	I	
DB0 I DB7	PAGE 6	X=6
DB0 I DB7	PAGE 7	X=7

**Address Configuration of Display RAM** 

#### (5) Status Read

	R/W	D/I	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
Code	1	0	BUSY	0	ON/OFF	RESET	0	0	0	0

BUSY: When BUSY is 1, The LSI is in internal operation. No instructions are accepted while BUSY is 1, so you should make sure that BUSY is 0 before writing the next instruction.

ON/OFF: This bit show the liquid crystal conditions ON condition or OFF condition.

When ON/OFF is 1, the display is on OFF condition. When ON/OFF is 0, the display on ON condition.

Status Read instruction cannot be accepted.

RESET: RESET=1 shows that the system is being initialized. In this condition, any instructions except

RESET=0 shows that initializing has finished and system is in the usual operation.

#### (6) Write Display Data

,	R/W	D/I	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
Code	0	1	D	D	D	D	D	D	D	D

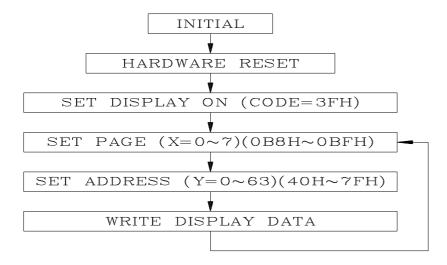
Writes 8-bit data DDDDDDDD (binary) into display data RAM. The Y address is increased by 1 automatically.

#### (7) Read Display Data

	R/W	D/I	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
Code	1	1	D	D	D	D	D	D	D	D

Reads out 8-bit data DDDDDDD (binary) from the display data RAM. The Y address is increased by 1 automatically. One dummy read is necessary soon after the address setting.

#### 12. Initializing And Programming



#### 13. Reliability Condition

13. Kenabinty	3. Renability Condition											
			TN	Гуре	STN	Type						
			Normal Temp.	Wide Temp.	Normal Temp.	Wide Temp.						
Viewing	Horizontal 4	)	±30°	±30°	±30°	±30°						
Angle	Vertical ⊖ (m	1)	10° to 30°	10° to 30°	-10° to 40°	-10° to 40°						
Operating	g Temperature		-10 to 70°C	-25 to 80°C	0 to 50°C	*-20 to 70°C						
Storage	Temperature		-20 to 80°C	-35 to 90°C	-20 to 70°C	*-30 to 80°C						
High Temper	rature (Power Of	f)	240 Hours @70°€	240 Hours @90°€	240 Hours @65°€	240 Hours @75°C						
Low Temper	ature (Power Off	()	240 Hours @-20°€	240 Hours @-35°C	240 Hours @-15°C	240 Hours @-25°C						
High Temper	rature (Power Or	1)	240 Hours 240 Hours @70°C @80°C		240 Hours @60°C	240 Hours @70°C						
Low Temper	rature (Power On	)	240 Hours @-10°C	240 Hours @-25°C	240 Hours @-10°C	240 Hours @-20°C						
High Temp	perature & High		55°C/90%RH	75°C/90%RH	45°C/90%RH	65°C/90%RH						
Hı	umidity		240 Hours	240 Hours	240 Hours	240 Hours						
Thermal Shock	<u>C</u>	A	60min@-20°C	60min@-35°C	60min@-20°℃	60min@-30°C						
5 Cycle	5 Cycle B B		5min@25°℃	5min@25°℃	5min@25°℃	5min@25°℃						
LA		C	60min@70°C	60min@90°C	60min@70°C	60min@80°C						
Expo	ected Lift		50,000 Hours	50,000 Hours	50,000 Hours	50,000 Hours						

Wide temp. version may not available for some products, Please consult our sales engineer or respresentative.

#### 14. Functional Test & Inspection Criteria

14.1 Sample plan

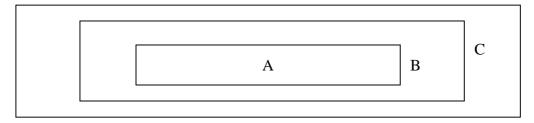
Sample plan according to MIL-STD-105D level 2, and acceptance/rejection criteria is.

Base on: Major defect: AQL 0.65 Minor defect: AQL 2.5

## 14.2 Inspection condition

Viewing distance for cosmetic inspection is 30cm with bare eyes, and under an environment of 800 lus (20W) light intensity. All direction for inspecting the sample should be within 45° against perpendicular line.

#### 14.3 Definition of Inspection Zone in LCD



Zone A: Character / Digit area

Zone B : Viewing area except Zone A ( Zone A + Zone B = minimum Viewing area )

Zone C: Outside viewing area (invisible area after assembly in customer's product)

Note: As a general rule, visual defects in Zone C are permissible, when it is no trouble for quality and assembly of customer's product.

#### 14.4 Major Defect

All functional defects such as open (or missing segment), short, contrast differential, excess power consumption, smearing, leakage, etc. and overall outline dimension beyond the drawing. Are classified as major defects.

#### 14.5 Minor Defect

Except the Major defects above, all cosmetic defects are classified as minor defects.

	Except the Major dere							
Item No.	Item to be Inspected		Inspection Standard					Classification of
							defects	
1.	Spot defect	Zone siz	ze (mm)	Ad	ccepta	ble (	<b>Q</b> ty	Minor
	( Defects in spot			A	F	3	С	
	from )	Ф≦	0.15	Acce	ptable	;	Accepta-	
				( cluterin	g of s	pot	ble	
				not all	owed	)		
		0.15≦₫	5 ≤ 0.20	1	2	2		
		0.20≦₫	5 ≤ 0.25	0	1			
		Ф>(	0.25	0	(	)		
		Remarks:	for dark/w	hite spot, s	size (	D is	defined as	
			$\Phi = 1/2(X +$	·Y)				
2.	Line defect		Size (mm)	(mm)		cepta	able Qty	Minor
	( Defects in line	L	V	V	Zone			
	form )	Length	Wi	dth	A	В	С	
		Accep-	W≦	0.02	Acc	ер-	Accep-	
		table	- 1		tab	ole	table	
		L≦3.0 W≦		0.03	2	2		
		L>2.5 W≦		0.03	0			
		L≦3.0	0.03 <b>&lt;</b> W	<i>I</i> ≤0.05	2			
		L>2.5	0.03 <b>&lt;</b> W	<i>I</i> ≤0.05	(	)		

			W	0.05	Countac	l as spot	
			VV >	3.03		Follows	
					`	4.5.1)	
		Domortza	The total o	f anot dafa			
			The total o shall not ex	-	et and fine	defect	
3.	Orientation defeat	1			( <b>7</b>	\ on <b>7</b> ono	Minon
3.	Orientation defect	Not allow	ved inside	_	ea (Zone F	A or Zone	Minor
	(such as			B )			
	misalignment of						
	L/C)	145415	1 ' 5	•.•			3.6
4.	Polarizing		olarizer Po				Minor
			ing in Posit		l not excee	d the	
			outline dir				
			nplete cove	-	viewing a	rea due to	
		Shifti	ing is not a	llowed.			
		14.5.4.2 S	eratches, b	ubble or de	nt on Glas	s/	
		P	olarizer/Re	flector, Bu	bble betwe	een	
		P	olarizer &	Reflector/C	Glass:		
		Size	(mm)	Acceptable Qty			
					Zone		
				A	В	С	
		Φ≦	0.20	Acce	otable	Accep-	
		0.20<₫	0 ≤ 0.50	3		table	
		0.50< ₫	o ≤ 1.00	2	2		
		Φ>	1.00	(	)		